KC Link Auto COG, Ceramic, 6200 pF, 2\%, 650 VDC, COG, SMD, MLCC, FT-CAP, Ultra-Stable, 2220


| Dimensions |  |
| :---: | :---: |
| Chip Size | 2220 |
| L | $6.1 \mathrm{~mm}+/-0.75 \mathrm{~mm}$ |
| W | $5 \mathrm{~mm}+/-0.4 \mathrm{~mm}$ |
| T | $2.5 \mathrm{~mm}+/-0.20 \mathrm{~mm}$ |
| B | $0.7 \mathrm{~mm}+/-0.35 \mathrm{~mm}$ |


| Packaging Specifications |  |
| ---: | :--- |
| Weight: | 320 mg |
| Packaging: | T\&R, 330mm, Plastic Tape |
| Packaging Quantity: | 2000 |


| General Information |  |
| ---: | :--- |
| Series: | KC Link Auto COG |
| Style: | SMD Chip |
| Description: | SMD, MLCC, FT-CAP, Ultra- <br> Stable |
| Features: | FT-CAP, Ultra-Stable |
| RoHS: | Yes |
| Termination: | Flexible Termination |
| Marking: | No |
| Qualifications: | AEC-Q200 |
| AEC-Q200: | Yes |
| Shelf Life: | 78 Weeks |
| MSL: | 1 |


| Specifications |  |
| ---: | :--- |
| Capacitance: | 6200 pF |
| Measurement Condition: | 1 kHz 1.0 Vrms |
| Capacitance Tolerance: | $2 \%$ |
| Voltage DC: | 650 VDC |
| Dielectric Withstanding <br> Voltage: | 845 VDC |
| Temperature Range: | $-55 /+150^{\circ} \mathrm{C}$ |
| Temperature Coefficient: | COG |
| Capacitance Change with <br> Reference to +25 <br> Applied (TCC): | $30 \mathrm{ppm} / \mathrm{C}, 1 \mathrm{kHz} 1.0 \mathrm{Vrms}$ |
| Dissipation Factor: | $0.1 \% 1 \mathrm{kHz} \mathrm{1.0Vrms}$ |
| Aging Rate: | $0 \% \mathrm{Loss} /$ Decade Hour |
| Insulation Resistance: | 100 GOhms |

